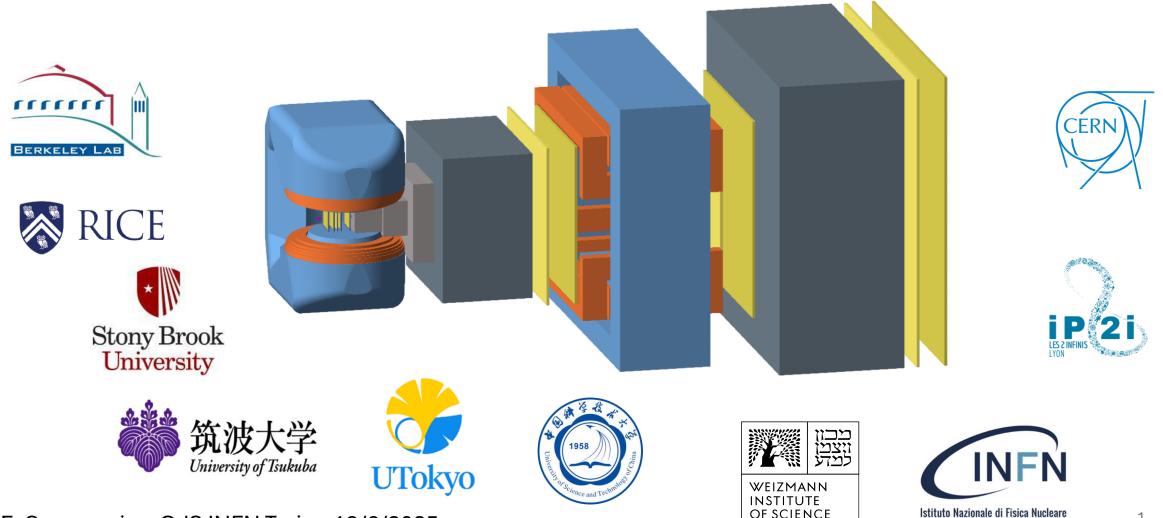
NA60+/DiCE: Study of Rare Probes of the Quark-Gluon Plasma at SPS Energies

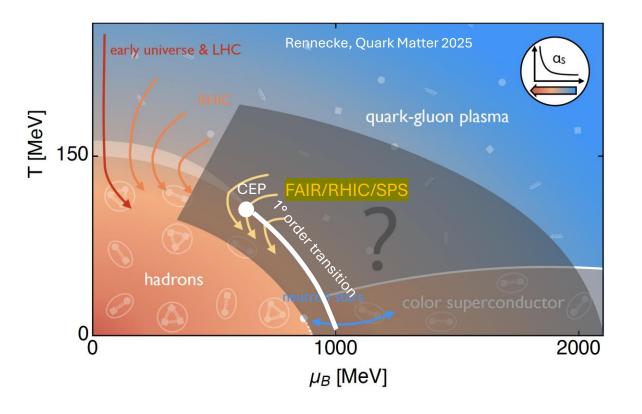


E. Scomparin – CdS INFN Torino 13/6/2025

Heavy Ions at the SPS: a Bridge Between Early Universe and Neutron Stars



High-energy Heavy ion collisions:
 Tools for investigating QCD phase diagram varying collision energy



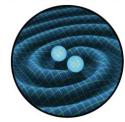
- $\hfill\square$ QCD phase diagram at low μ_B :
 - \circ Early Universe conditions
 - o Cross-over phase transition
- $\hfill\square$ QCD phase diagram at high μ_{B} :
 - Largely unexplored
 - $\circ~$ Existence of Critical End Point and 1st order transition:
 - predicted in SPS/FAIR μ_B range



Exploration at CERN SPS crucial

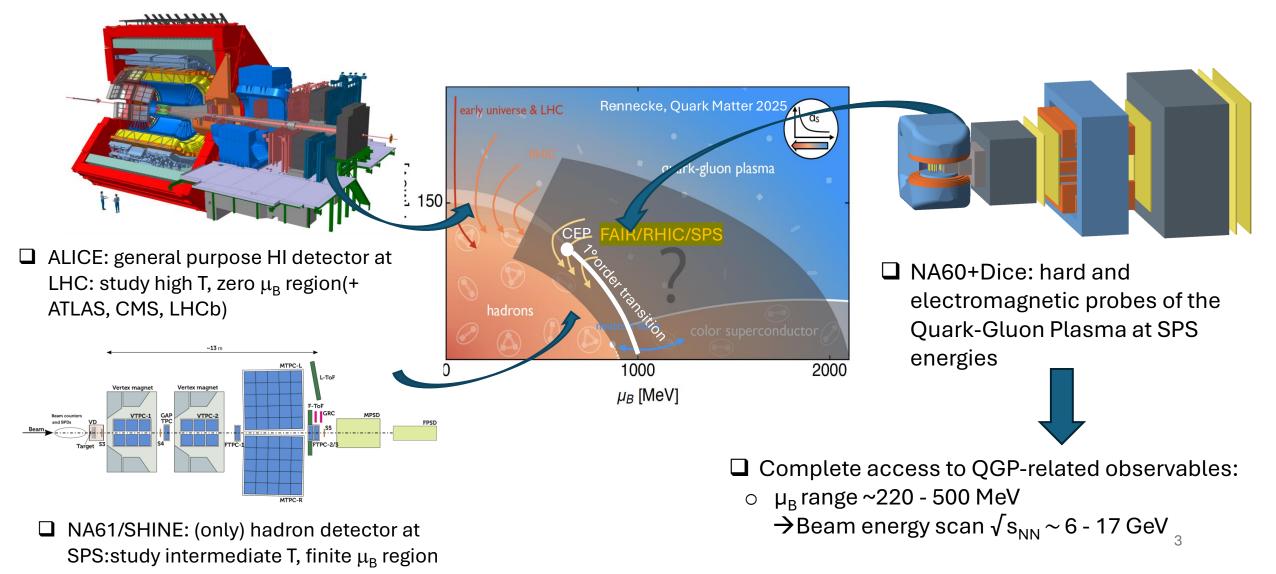
multi-messenger astronomy

- **□** Equation of state of quark matter:
 - $\circ~$ Large interest also in astrophysics
 - e.g. neutron stars



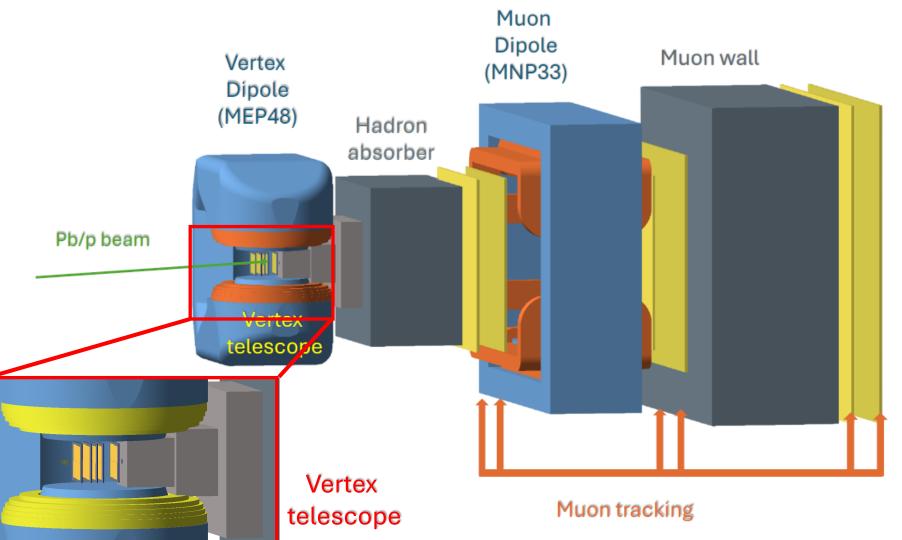
CERN's Unique Capabilities for Phase Diagram Exploration and the NA60+/DiCE Experiment (DiMuon and Charm Experiment)

CERN provides unparalleled coverage of the QCD phase diagram across baryochemical potential



The NA60+ Apparatus – Precision Engineered for Rare Probes

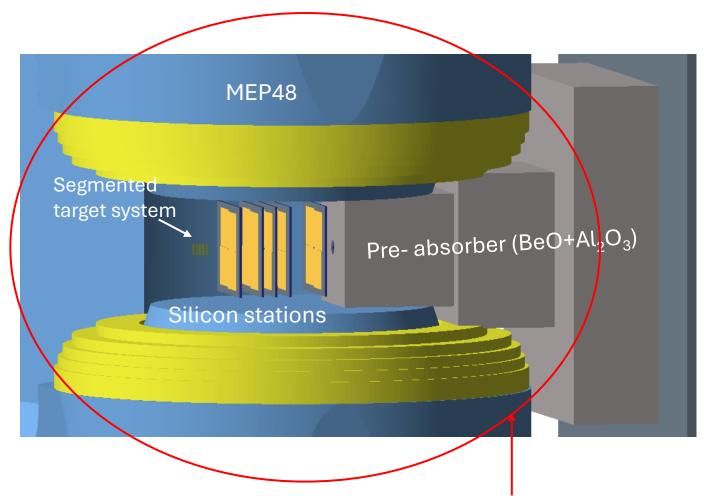
- Inspired by the former NA60 detector (2002-2004)
- □ Two key components:
- o Muon Spectrometer
- O Silicon vertex Spectrometer
 → Track matching
- □ Beam energy scan:
- vary z-position of the muon spectrometer and thickness of hadron absorber
- Rare processes:
 10⁶ Pb ions/s
 5x10⁷ protons/s



Significant evolution of the design of the LoI (2023)

The Vertex Spectrometer's Pixel Detector – Precision at the Edge

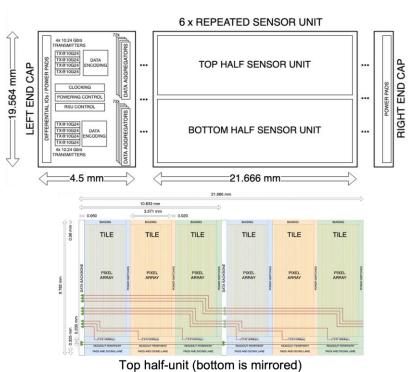
- □ Primary function of the vertex spectrometer (VS):
 - Measure the kinematic of muons and hadrons before the hadron absorber
 - $\circ~$ Five identical silicon pixel stations positioned at 7 < z < 38~cm
- □ Requirements for silicon sensors:
 - Maximize pixel coverage across angular acceptance
 - $\circ~$ Spatial resolution 5 μm
 - Only Si material budget <0.1% in 2 planes closest to targets
 - Operation at 150 kHz interaction rate
 - Max radiation hardness: 10¹⁴ 1 MeV n_{eq}/cm² over a decade of operation (first plane, region close to beam)



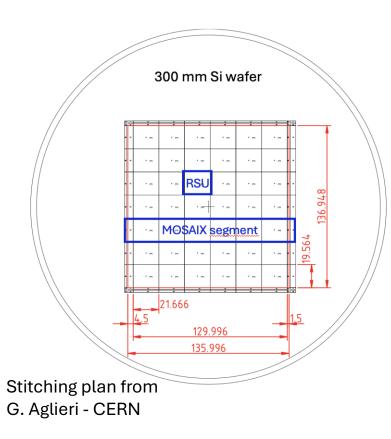
Main responsibility of Italian groups

Silicon Pixel Technology – Breaking Area Boundaries

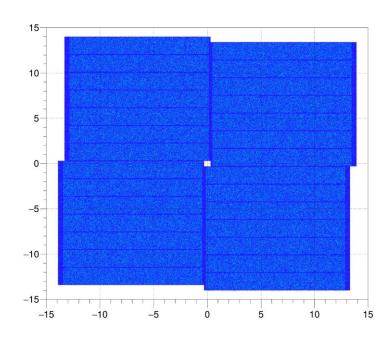
- □ Synergy with ALICE ITS3 project
- □ Basic units designed in reticle:
 - RSU: 21.67x19.56 mm² pixel matrix
 - Pixel pitch 20.5 μm
 - Digital periphery with 8 10.24 Gb/s serializers



- □ NA60+/DiCE sensor :
 - MOSAIX segment with 6 RSU
 - 7 MOSAIX segments replicated vertically



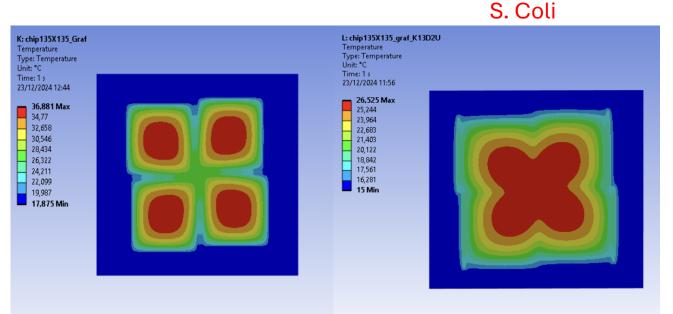
- Largest silicon station inside MEP48:
 - 4 stitched 13.6x13.6 cm² sensors



- Sensors with variable number of segments :
 - Advantage: increase sensor yield/wafer

Cooling&Mechanics – Low Material Budget under Power

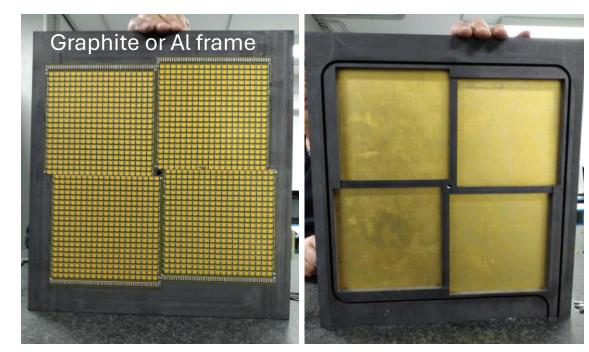
- □ Cooling imposes constraints to the mechanical system:
- 40 mW/cm² power dissipation in pixel matrix (+ 790 mW/cm² in periphery)
- Goal 25 °C over sensor surface



COMSOL/ANSYS simulations:

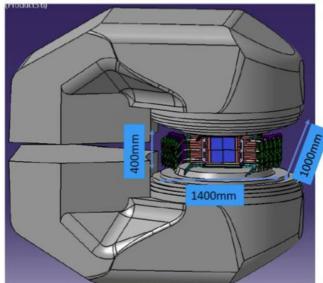
- Mixed water (18-20 °C)+ air cooling (1-2 m/s)
- 0.4 mm carbon fiber substrate to improve heat dissipation in larger planes

- Carbon fiber substrate glued on periphery frame (graphite or aluminum):
 - Machined groove to accommodate a stainless steel pipe for water cooling

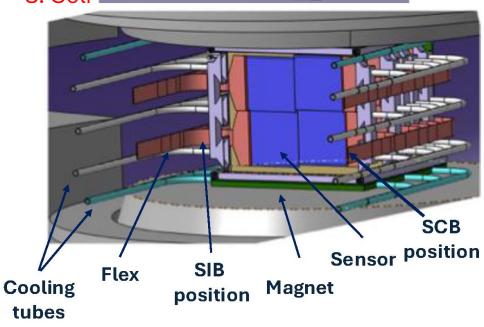


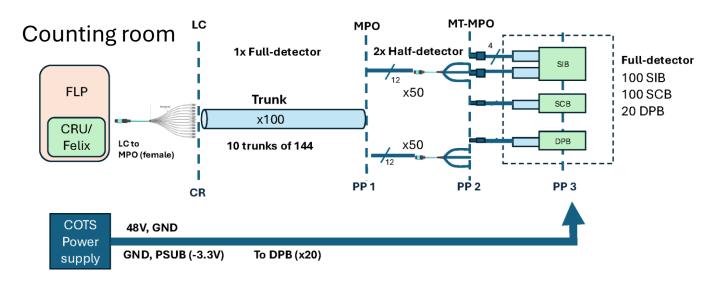
- □ Simulations calibrated on a test set-up:
 - PCBs with resistor arrays mounted on graphite frame to mimic power dissipation

Vertex Spectrometer: Compact integration







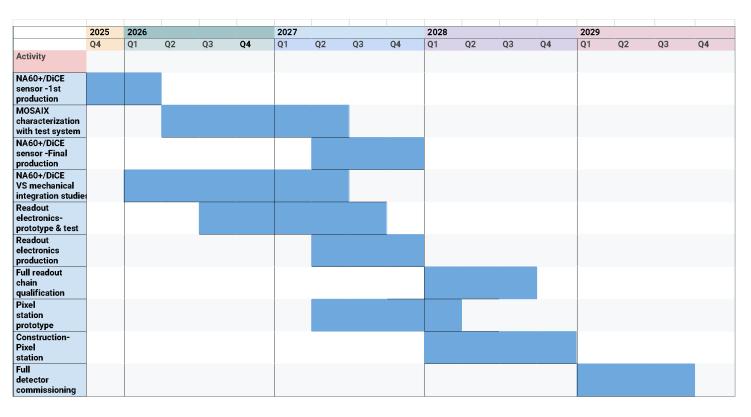


□ Versatile Link+ system for readout and DCS:

- Bidirectional high-speed 10 Gb/s optical communication system
- minimal on-detector footprint (only Electric to Optical conversion and low-voltage power boards)
- $\circ~$ Optical fibers connect directly to counting room
- **Counting room:**
 - 35 CRU/FELIX hosted in First Level Processors (FLPs)
- Powering with CAEN mainframe SY4527 with OPC server and gigabit Ethernet hosting
- □ System of pipes for air and water cooling:
 - \circ Air compressed and chillers included in integration study $_8$

Vertex Spectrometer: Construction Timeline

- Pixel stations constructed and tested at Cagliari/Torino INFN Labs (Berkeley and Lyon/Grenoble participation under discussion):
- Facilities with probe-stations, wire-bonding machines in both labs
- Long-standing record of constructing/characterization of silicon MAPS (ALICE ALPIDE, MOSS, MOSAIX)
- Synergy with ALICE ITS3
- Approximately 50 wafer will be produced (preliminary):
 - Contingency to take into account yield fraction and replacements for malfunctions and radiation damages
- Timeline:
 - Prototyping: 2026
 - Productions and construction: 2027-28
 - o Commissioning: 2029



Prototyping the mechanics

Current design (proposal) foresees 4 large sensors in each station, identically replicated 5 times
 Two potential problems

 \Box Presence of dead regions in the central part of the sensors \rightarrow acceptance reduction

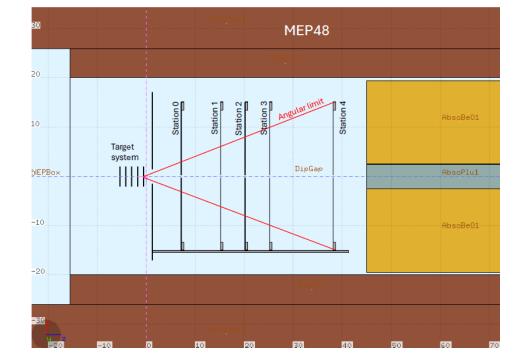
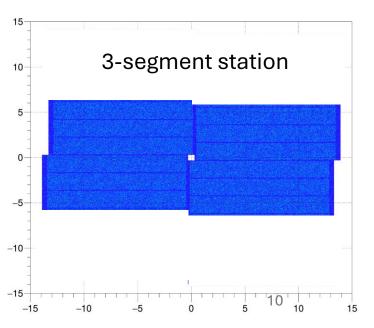


Table 1: MOSAIX readout segments by station.

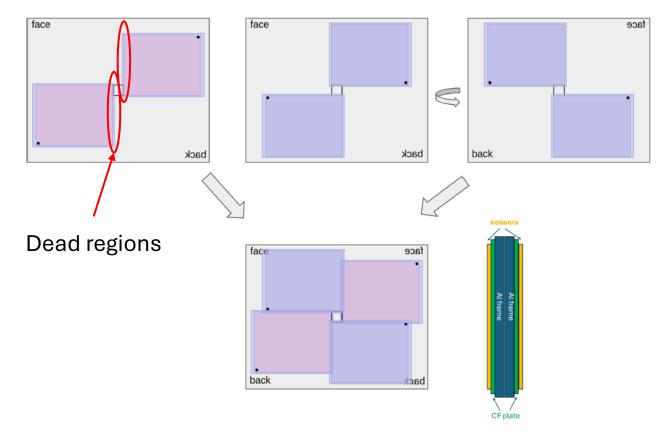
Station	Instrumented segments/sensor	Instrumented segments/station
0	3	12
1	4	16
2	5	20
3	6	24
4	7	28



Prototyping the mechanics

Current design foresees 4 large sensors in each station, identically replicated 5 times

- Two potential problems
 - \square Presence of dead regions in the central part of the sensors ightarrow acceptance reduction
 - □ Peripheral region of the upstream sensors outside acceptance → can costs be reduced with smaller sensors ?



□ A station could be constructed using two half planes, each one having two sensors

□ In this way sensors can be staggered in such a way to eliminate the dead region in the central part of the station

Requests for 2026

In 2026 we need to finalize the production of a prototype of the station
 CSN3 funded a first production of sensors

□ For the mechanics we need

□ CAD project for the optimization of the geometry

Further simulations with ANSYS/COMSOL to investigate the cooling in the alternative set-ups described in the previous slides

→ Progettazione meccanica , 2 m.u. (Coli)

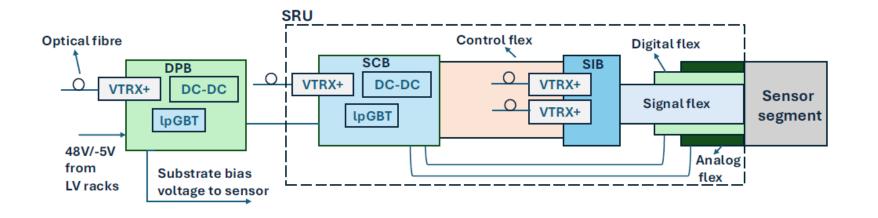
Production of new frames for sensors

 \Box Different materials \rightarrow graphite, aluminium

 \Box Different sizes \rightarrow to accommodate a different number of segments

→ Officina meccanica, 2 m.u. (Panero)

Study of readout/connections

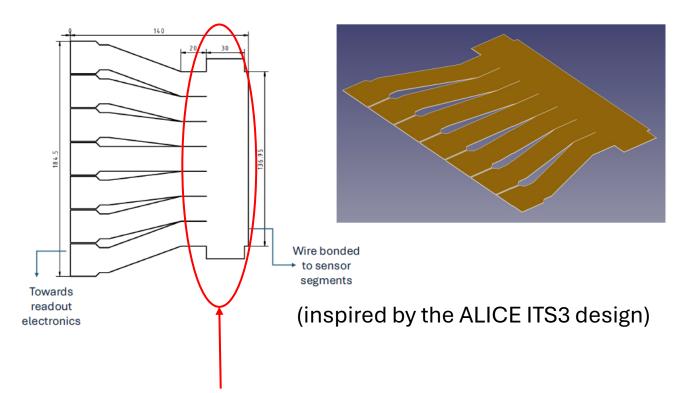


3 to 7 segments for each sensor, depending on the station

Fig. 29: The readout scheme for the vertex spectrometer. It consists of a logical Segment Readout Unit (SRU), which includes a Segment Interface Board (SIB), a Segment Control Board (SCB) and flexible printed circuits. There is a Detector Power Board (DPB) that supplies the SCB and the sensor substrate.

- □ 100 segments in total
- □ R/O rate (whole spectrometer): 60 GBps

Flex for the vertex spectrometer



Common area for the analog, digital and signal flex, which are wire-bonded to the sensor

- Analog flex
- connects the analog power domain of the sensor segment.
- Digital flex
- connects the digital power domain of the sensor segment.
- Signal flex
- connects the high-speed data lines of the sensor segment.
- Control flex
- connects the SCB to the SIB to provide the clock to the VTRX+ hosted on the SIB

Requests for 2026

□ In 2026 we need to

□ Finalize the design of the flex (part of the activity in common with ALICE ITS3)
 → Laboratorio elettronica, 2 m.u. (Benotto)

Perform test of wire bonding of large sensors from the first production, foreseen for end 2025
 Laboratorio elettronica, 2 m.u.

(further remarks at the end of the presentation)

Approval path of the experiment

Proposal submitted (https://cds.cern.ch/record/2932302) and presented to the SPSC on May 27

Informazioni File	
	Scientific Committee Paper
Report number	CERN-SPSC-2025-023 ; SPSC-P-373
Title	NA60+/DiCE: study of rare probes of the Quark-Gluon Plasma at SPS energies
Project Manager/Technical Coordinator	Scomparin, Enrico; Usai, Gianluca
Author(s)	NA60+/DiCE Collaboration Visualizza tutti i 74 autori
Corporate author(s)	CERN. Geneva. SPS and PS Experiments Committee ; SPSC
Series	(Proposal)
Submitted by	enrico.scomparin@cern.ch on 16 May 2025
Subject category	Detectors and Experimental Techniques
Abstract	We propose a new fixed-target experiment, NA60+/DiCE (Dilepton and Charm Experiment), for the study of electromagnetic and hard probes of the Quark-Gluon Plasma (QGP) in heavy-ion collisions at the CERN SPS. The experiment aims at performing measurements of the dimuon spectrum from threshold up to the charmonium region, of hadronic decays of charm hadrons, and of strange hadrons and hypernuclei. It is based on a muon spectrometer, which includes the MNP33 dipole magnet and six planes of tracking detectors, coupled to a vertex spectrometer, equipped with five planes of Si MAPS immersed in the dipole field of the MEP48 magnet. The collision energies range from $\sqrt{s_{NN}} = 6.3$, GeV ($E_{lab} = 20$ A, GeV) to the top SPS energy ($\sqrt{s_{NN}} = 16.8$, GeV, $E_{lab} = 150$ A, GeV). High luminosity is an essential requirement for the experiment, which needs to collect at each energy up to 10^{12} Pb ions incident on a 15\% interaction probability Pb target. Corresponding data taking periods, at the same energy per nucleon, with a proton beam incident on various nuclear targets and a similar integrated luminosity per nucleon collision, are also needed. This document presents the physics program, the experimental set-up including integration and radio-protection studies, the beam requirements and the expected physics performance. An evaluation of the costs, of the sharing of responsibilities among the participating institutes, and of the construction and running timeline are also presented.

Approval path of the experiment

Proposal submitted (<u>https://cds.cern.ch/record/2932302</u>) and presented to the SPSC on May 27 Draft minutes extremely positive "Standard" questions asked



Recommendation of SPSC could be given in September meeting \rightarrow then endorsement by the CERN RB

Conclusion

Toward the approval of a new experiment at CERN Non-negligible goal \rightarrow only 7 new experiments at the SPS in the last 25 years

Technical support of INFN Torino essential for the finalization of the R&D phase (2026) and Construction (2027-2029)

	2025	2026	2027	2028	2029	2030
Detector prototyping						
Detector production						
Installation						
Commissioning				1 1 1		
Physics data taking				 		

Medium-term plan

□ N.B.: feedback from the SPSC arrived only ~1 week ago, planning is just starting

□ Italian groups (Torino, Cagliari) have the main coordination role in the experiment and in the project of the vertex spectrometer

□ From 2027 the contribution of the electronics lab, mechanics design and workshop will be essential for the success of the experiment

□ In particular we need to build in Torino part of the stations

 \rightarrow Current idea is that one lab produces stations with a given number of segments

□ This will imply the availability of facilities and tools to mount the stations that will be assigned to Torino

Depending on the schedule and results of the production of the sensor prototypes, some activities on their characterization (e.g. test with probe card) might be started already in 2026, with the need of lab space. Timeline and equipment still under discussion

Esperimento (sigla nel database INFN)	NA60_PLUS
N.B Nel caso di grandi esperimenti con sottogruppi interni le informazioni vanno fornite per lo specifico sottogruppo: EG CMS-TK, ALICE-ITS, etc	
Ruoli di responsabilità nazionali ed internazionali ricoperti all'interno della collaborazione/esperimento da personale della Sezione	E. Scomparin (RN e co-coordinatore del progetto)
Numero di FTE coinvolti (ricercatori e tecnologi) nel gruppo locale, compresi dottorandi e post-doc	~4.8
Responsabile scientifico locale dell'attività richiesta	E. Scomparin
Servizio in cui si richiede l'attività (Servizio di Progettazione Meccanica, Officina Meccanica, Centro di Calcolo, Laboratorio di Elettronica)	Laboratorio di Elettronica
Altri servizi a a cui si richiedono attività strettamente correlate alla presente (indicare solo il nome del servizio)	
Specificare se si tratta di nuova attività o continuazione di attività già approvata e supportata in anni precedenti. In caso di attività pluriennali in corso indicare l'anno di inizio e l'anno previsto per la conclusione	Continuazione attivita', esperimento in fase di approvazione del CERN (proposal presentato a maggio 2025). Previste attivita' fino alla finalizzazione del rivelatore (2028-2029)
Descrizione tecnica sintetica dell'attività richiesta (max 1 pagina) Dove applicabile, la descrizione deve fornire elementi quantitativi, indicando, ad esempio, il numero di pezzi meccanici da fabbricare, il numero di schede di elettronica da assemblare o testare, il numero di chip da bondare, etc). Non sono ammesse schede complessivamente superiori a due pagine.	L'esperimento NA60+ includerà uno spettrometro di vertice basato su MAPS. E' iniziata nel 2024 una attività di progetto di flex cables per lo studio delle connessioni dei sensori. Nel corso del 2026 e' prevista la realizzazione del prototipo di un piano del rivelatore, che includera' la prima versione del sensore, con la relativa meccanica di supporto, i circuiti di raffreddamento e, nell'ottica di questa richiesta, la realizzazione di sistemi di flex interfacciati a link ottici. Parte dell'attività è in comune con il lavoro sull'ITS3 di ALICE (stesso sensore ma diversa geometria, collider vs fixed-target), in cui è coinvolto Franco Benotto. La stima è di circa 2 mesi uomo. Inoltre, prevediamo un'attivita' di bonding di sensori stitched a grande area, su macchina da bond automatica, con una stima di 2 mesi uomo.
Milestones	L'attivita' di cui sopra e' parte integrante del progetto dello spettrometro di vertice cosi' come dettagliato nel proposal dell'esperimento (<u>https://cds.cem.ch/record/2932302</u>), e la sua realizzazione nel 2026 e' strumentale alla finalizzazione del prototipo in vista della realizzazione dei sensori finali e della relativa catena di read-out

Elettronica

Esperimento (sigla nel database INFN)	NA60_PLUS
N.B Nel caso di grandi esperimenti con sottogruppi interni le informazioni vanno fornite per lo specifico sottogruppo: EG CMS-TK, ALICE-ITS, etc	
Ruoli di responsabilità nazionali ed internazionali ricoperti all'interno della collaborazione/esperimento da personale della Sezione	E. Scomparin (RN e co-coordinatore del progetto)
Numero di FTE coinvolti (ricercatori e tecnologi) nel gruppo locale, compresi dottorandi e post-doc	~4.8
Responsabile scientifico locale dell'attività richiesta	E. Scomparin
Servizio in cui si richiede l'attività (Servizio di Progettazione Meccanica, Officina Meccanica, Centro di Calcolo, Laboratorio di Elettronica)	Servizio di Progettazione Meccanica
Altri servizi a a cui si richiedono attività strettamente correlate alla presente (indicare solo il nome del servizio)	
Specificare se si tratta di nuova attività o continuazione di attività già approvata e supportata in anni precedenti. In caso di attività pluriennali in corso indicare l'anno di inizio e l'anno previsto per la conclusione	Continuazione attivita', esperimento in fase di approvazione del CERN (proposal presentato a maggio 2025). Previste attivita' di progettazione meccanica fino al 2029
Descrizione tecnica sintetica dell'attività richiesta (max 1 pagina) Dove applicabile, la descrizione deve fornire elementi quantitativi, indicando, ad esempio, il numero di pezzi meccanici da fabbricare, il numero di schede di elettronica da assemblare o testare, il numero di chip da bondare, etc). Non sono ammesse schede complessivamente superiori a due pagine.	I gruppi italiani di NA60_PLUS hanno la responsabilita' per la progettazione e costruzione dello spettrometro di vertice basato su grandi sensori MAPS (13.5x13.5 cm2). Il raffreddamento di oggetti cosi' grandi pone problemi non indifferenti, attualmente in studio con la realizzazione di frame che contengono 4 sensori ciascuno. Nei frame sono inseriti dei tubi di raffreddamento nei quali scorre del fluido. Un ulteriore raffreddamento ad aria e' necessario per ottenere una temperatura uniforme su tutto il sensore. Studi dettagliati di simulazione di questo sistema di raffreddamento, con l'uso del pacchetto ANSYS, sono stati effettuati e validati con specifici set-up di test. Recentemente, sono stati discussi dei set-up alternativi, con un diverso posizionamento dei sensori, che permettono di diminuire gli spazi morti
	nell'accettanza del rivelatore e che richiedono ulteriori simulazioni, con lo scopo di finalizzare il sistema di cooling nel corso del 2026. Un impegno di almeno 2 mesi-persona (S. Coli) e' necessario per questa attivita'.
Milestones	Entro il 2026 e' previsto il test della prima versione dei sensori dell'esperimento, con relativa catena di read-out e prototipo della meccanica e del cooling, in vista dell'inizio della produzione finale nel 2027

Progettazione meccanica

Esperimento (sigla nel database INFN)	NA60_PLUS
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Altri servizi a a cui si richiedono attività strettamente correlate alla presente (indicare solo il nome del servizio)	
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Milestones	L'attivita' di cui sopra e' parte integrante del progetto dello spettrometro di vertice cosi' come dettagliato nel proposal dell'esperimento (<u>https://cds.cem.ch/record/2932302</u>), e la sua realizzazione nel 2026 e' strumentale alla finalizzazione del prototipo in vista della realizzazione dei rivelatori per l'esperimento.

Officina meccanica

Backup

Cost Estimate

• Overall low cost, while maintaining very high-precision capabilities with state-of-the art detector technologies: • Very advantageous ratio of scientific outcome/financial investment

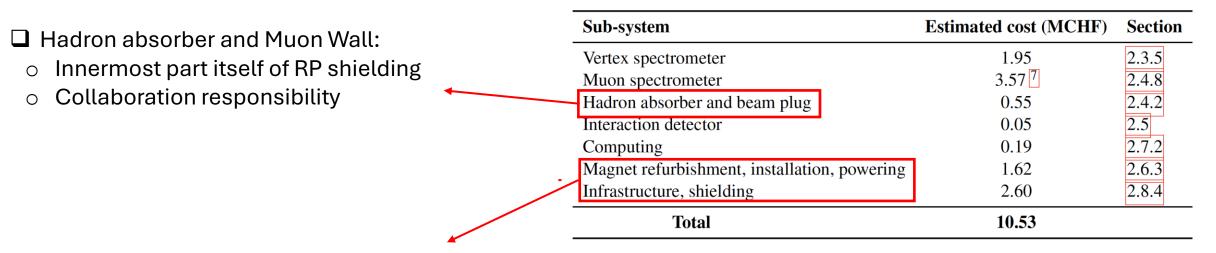
Sensor (including thin.		. ,	Total Cost (kC)	(HF)	Detailed cost breakdown of detector su	havetome	
Sensor stitching plan	e e,	10000	500 100		Detailed cost breakdown of detector su	DSystems	
Segment Interface Boa	oard (SIB) 130	540	70				
Segment Control Boar	ard (SCB) 130	920	120		Such avistom	Estimated cost (MCHF)	Section
Detector Power Board		1000	35		Sub-system	Estimated cost (within)	Section
Flex Optical fibres and pate	60 tch papels	-	100 100				
Optical fibres and pate CRU/FELIX		10000	500		Vertex spectrometer	1.95	2.3.5
First Level Processor (10000	150		Å	_	
Mechanical integration		-	170		Muon spectrometer	3.57 7	2.4.8
Power supplies and ca	ables -	-	75				
Racks	-	-	30		Hadron absorber and beam plug	0.55	2.4.2
Total .			1950	4	Interaction detector	0.05	2.5
lement	Component	Unit cost	Units	Total			
Iodules	PCB	900	270	243k	Computing	0.19	2.7.2
	Custom-made components	various	various	250k 140k			
	Off-shelf components Wires	various 900	various 60 km	140k 54k	Magnet refurbishment, installation, powering	1.62	2.6.3
	Total	1 100	00 кн.			2.60	
				690k	Infrastructure, shielding	2.60	2.8.4
lectronics	Strip extension board connectors		256	9k			
	Dual-VMM mezzanine Baadout Controllor mezzanina	572	1025	540k	Total	10.53	
	Readout Controller mezzanine	604	256	155k	IUMI	10.00	
	Module Deadout Unit	2700					
	Module Readout Unit DAO back end	2700	18	49k 17k			
	DAQ back end	2700	18	17k			
		2700	18				
	DAQ back end Low voltage	2700		17k 62k	Cost of detector system dominated by	Vertex and Muon	spectromet
echanical frames	DAQ back end Low voltage Data cables	2700	6	17k 62k 13k	Cost of detector system dominated by		spectromet
	DAQ back end Low voltage Data cables Total Material	various	6	17k 62k 13k 845k 100k	, , , , , , , , , , , , , , , , , , ,		spectromet
	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS	various 400	6 12×250 d	17k 62k 13k 845k 100k 1,200k	 Cost of detector system dominated by Detailed cost breakdown discussed i 		spectromet
	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC	various 400 160	6	17k 62k 13k 845k 100k	, , , , , , , , , , , , , , , , , , ,		spectromet
	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS	various 400 160	6 12×250 d 5×500 d	17k 62k 13k 845k 100k 1,200k 400k	, , , , , , , , , , , , , , , , , , ,		spectromet
	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & elect. engineer, WIS	various 400 160 5 425	6 12×250 d 5×500 d 300 d	17k 62k 13k 845k 100k 1,200k 400k 128k	, , , , , , , , , , , , , , , , , , ,		spectromet
	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & elect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS M.S. student, USTC	various 400 160 5 425 30k, 40k 29,5k 15k	6 12×250 d 5×500 d 300 d 4, 6 y 2 y 3 y	17k 62k 13k 845k 100k 1,200k 400k 128k 360k 59k 45k	, , , , , , , , , , , , , , , , , , ,		spectromet
	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & elect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS	various 400 160 5 425 30k, 40k 29,5k 15k	6 12×250 d 5×500 d 300 d 4, 6 y 2 y	17k 62k 13k 845k 1,00k 400k 128k 360k 59k	, , , , , , , , , , , , , , , , , , ,		spectromet
	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & elect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS M.S. student, USTC	various 400 160 5 425 30k, 40k 29,5k 15k	6 12×250 d 5×500 d 300 d 4, 6 y 2 y 3 y	17k 62k 13k 845k 100k 1,200k 400k 128k 360k 59k 45k	, , , , , , , , , , , , , , , , , , ,		spectromet
Mechanical frames Manpower Consumables	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & elect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS M.S. student, USTC Experts, short-term, WIS & UST	various 400 160 5 425 30k, 40k 29,5k 15k	6 12×250 d 5×500 d 300 d 4, 6 y 2 y 3 y	17k 62k 13k 845k 100k 1,200k 400k 128k 360k 59k 45k 100k	, , , , , , , , , , , , , , , , , , ,		spectromet
Manpower Consumables Jigh Voltage	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & elect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS M.S. student, USTC Experts, short-term, WIS & UST Total Glue, cleaning, gas, etc. Mainframe & units	Various 400 160 425 30k,40k 29.5k 15k rC various	6 12×250 d 5×500 d 300 d 4, 6y 2 y 3 y various	17k 62k 13k 845k 100k 1,200k 400k 128k 360k 59k 45k 100k 2.3M 50k 110k	, , , , , , , , , , , , , , , , , , ,		spectromet
Manpower Consumables High Voltage Fest bench	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & lect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS M.S. student, USTC Experts, short-term, WIS & UST Total Glue, cleaning, gas, etc. Mainframe & units Scintillators, mechanics	various 400 160 425 30k, 40k 29.5k 15k various various 40k, 9k various	6 12×250 d 5×500 d 300 d 4, 6 y 2 y 3 y various 1, 8 1	17k 62k 13k 845k 100k 1,200k 400k 128k 360k 59k 45k 100k 2.3M 50k 110k 20k	, , , , , , , , , , , , , , , , , , ,		spectromet
Manpower Consumables Jigh Voltage	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & lect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS M.S. student, USTC Experts, short-term, WIS & UST Total Glue, cleaning, gas, etc. Mainframe & units Scintillators, mechanics	various 400 160 30k, 40k 29.5k 15k rC various various 400	6 12×250 d 5×500 d 300 d 4, 6 y 2 y 3 y various 1, 8	17k 62k 13k 845k 100k 1,200k 400k 128k 360k 59k 45k 100k 2.3M 50k 110k	, , , , , , , , , , , , , , , , , , ,		spectromet
Manpower Consumables High Voltage Fest bench Shipping, WIS & USTC Assembly	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & lect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS M.S. student, USTC Experts, short-term, WIS & UST Total Glue, cleaning, gas, etc. Mainframe & units Scintillators, mechanics	various 400 160 425 30k, 40k 29.5k 15k various various 40k, 9k various	6 12×250 d 5×500 d 300 d 4, 6y 2 y 3 y various 1, 8 1 various 20	17k 62k 13k 845k 100k 1,200k 400k 128k 360k 59k 45k 100k 2.3M 50k 110k 20k 85k 14k	, , , , , , , , , , , , , , , , , , ,		spectromet
Manpower Consumables High Voltage Fest bench Shipping, WIS & USTC	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & elect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS M.S. student, WIS M.S. student, USTC Experts, short-term, WIS & UST Total Glue, cleaning, gas, etc. Mainframe & units Scintillators, mechanics C Flights Accommodation	various 400 160 425 30k, 40k 29.5k 15k 15k various 40k, 9k various various 700 60	6 12×250 d 5×500 d 300 d 4, 6 y 2 y 3 y various 1, 8 1 various 20 200 d	17k 62k 13k 845k 100k 1,200k 400k 128k 360k 59k 45k 100k 2.3M 50k 110k 20k 85k 14k 12k	, , , , , , , , , , , , , , , , , , ,		spectromet
Manpower Consumables High Voltage Fest bench Shipping, WIS & USTC Assembly	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & elect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS M.S. student, USTC Experts, short-term, WIS & UST Total Glue, cleaning, gas, etc. Mainframe & units Scintillators, mechanics C Flights Accommodation Per diem	various 400 160 425 30k, 40k 29.5k 15k Various various 40k, 9k various various 0 40k, 9k 0 0 0 0 0 0 0 0 0 0 0 0 0 0	6 12×250 d 5×500 d 300 d 4, 6 y 2 y 3 y various 1, 8 1 various 20 200 d 200 d	17k 62k 13k 845k 100k 1,200k 400k 128k 360k 59k 45k 100k 2,3M 50k 110k 20k 85k 14k 12k 18k	, , , , , , , , , , , , , , , , , , ,		spectromet
Manpower Consumables High Voltage Fest bench Shipping, WIS & USTC Assembly	DAQ back end Low voltage Data cables Total Material Mexico facility staff, WIS Technicians, USTC Designer & elect. engineer, WIS Post-docs, USTC, WIS Ph.D. student, WIS M.S. student, WIS M.S. student, USTC Experts, short-term, WIS & UST Total Glue, cleaning, gas, etc. Mainframe & units Scintillators, mechanics C Flights Accommodation	various 400 160 425 30k, 40k 29.5k 15k 15k various 40k, 9k various various 700 60	6 12×250 d 5×500 d 300 d 4, 6 y 2 y 3 y various 1, 8 1 various 20 200 d	17k 62k 13k 845k 100k 1,200k 400k 128k 360k 59k 45k 100k 2.3M 50k 110k 20k 85k 14k 12k	, , , , , , , , , , , , , , , , , , ,		spectromet

E. Scon Total

4.3M

Cost Estimate

Overall low cost, while maintaining very high-precision capabilities with state-of-the art detector technologies:
 Very advantageous ratio of scientific outcome/financial investment



Detailed cost breakdown of detector subsystems

□ Costs for magnets refurbishment, installation, power, infrastructure, shielding (CERN BE, HSE, EP-DT):

- Also very detailed cost breakdown discussed in proposal:
- 1 MCHF of these expenses for magnet powering needed only in LS4 during NA consolidation (new power convertes)

Collaboration: Responsibilities and Cost Sharing

Areas of contribution of institutes belonging to the NA60+/DiCE Collaboration

Institute	Sub-detector	
Istituto Nazionale di Fisica Nucleare, (INFN), Cagliari, Padova, Torino (Italy)	Vertex spectrometer (MAPS detector & read-out)	
Weizmann Institute of Science, Rehovot (Israel)	Muon spectrometer (MWPC detectors)	
Stony Brook University, NY (USA) University of Science and Technology	Muon spectrometer (MPGD detectors) Muon spectrometer (read-out electronics)	Infrastruc
of China, Hefei (China) Institut de Physique des 2 Infinis de Lyon, CNRS/IN2P3 (France)	Trigger detector (scintillator system)	 If the exp essentia to cover
CERN	Infrastructure, beam and magnet refurbishment	

Infrastructure, beam, magnets:

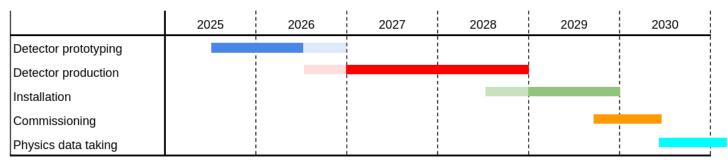
 If the experiment is approved, essential that CERN could be able to cover the corresponding costs

Institutes in the process
of joining the NA60+/DiCE
Collaboration

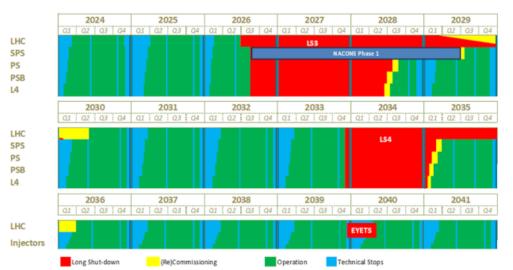
i	Institute	Area of interest
CE	Rice University, Houston, TX, USA	DAQ
	University of Tokyo, Tokyo, Japan	DAQ
	Fudan University, Shanghai, China	Simulation and data analysis
	University of Tsukuba, Ibaraki, Japan	Simulation and data analysis
	Lawrence Berkeley National Laboratory,	Vertex spectrometer / DAQ
	Berkeley, CA, USA	

Timeline for Construction and Data Taking

- □ Construction timeline defined to be ready for data taking in run4:
- \circ Assumes approval by 2025
- Discussion with funding agencies ongoing, SPSC recommendation is essential for this step
- o Availability of the CERN contribution (integration, magnets, beam line) important also for this step
- Tentative timeline for NA60+/DiCE from present to physics data taking:
 - Prototyping concluded in 2026
 - o Construction in 2027-28
 - o Commissioning in 2029



Long Term Schedule for CERN Accelerator complex



Seven years data-taking:

2030-2037 (LS4 taken into account)